#### 捷多邦,专业PCB打样工ISN54AHC32; SN74AHC32 QUADRUPLE 2-INPUT POSITIVE-OR GATES

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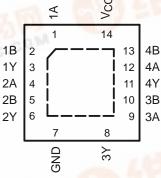
- Operating Range 2-V to 5.5-V V<sub>CC</sub>
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)

SN54AHC32 . . . J OR W PACKAGE SN74AHC32 . . . D, DB, DGV, N, NS, OR PW PACKAGE (TOP VIEW)

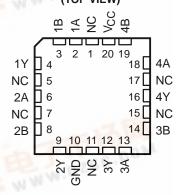




SN74AHC32...RGY PACKAGE



SN54AHC32 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

#### description/ordering function

The 'AHC32 devices are quadruple 2-input positive-OR gates. These devices perform the Boolean function  $Y = \overline{A} \bullet \overline{B}$  or Y = A + B in positive logic.

#### **ORDERING INFORMATION**

| TA             | PACKA         | GE <sup>†</sup> | ORDERABLE<br>PART NUMBER | TOP-SIDE<br>MARKING |
|----------------|---------------|-----------------|--------------------------|---------------------|
|                | QFN – RGY     | Tape and reel   | SN74AHC32RGYR            | HA32                |
|                | PDIP – N Tube |                 | SN74AHC32N               | SN74AHC32N          |
|                | SOIC - D      | Tube            | SN74AHC32D               | AHC32               |
| -              | 3010 = D      | Tape and reel   | SN74AHC32DR              | ALICOZ              |
| -40°C to 85°C  | SOP - NS      | Tape and reel   | SN74AHC32NSR             | AHC32               |
| A.             | SSOP – DB     | Tape and reel   | SN74AHC32DBR             | HA32                |
| 2.             | TSSOP – PW    | Tube            | SN74AHC32PW              | HA32                |
|                | 1330F - FW    | Tape and reel   | SN74AHC32PWR             | HASZ                |
|                | TVSOP – DGV   | Tape and reel   | SN74AHC32DGVR            | HA32                |
|                | CDIP – J      | Tube            | SNJ54AHC32J              | SNJ54AHC32J         |
| –55°C to 125°C | CFP – W       | Tube            | SNJ54AHC32W              | SNJ54AHC32W         |
|                | LCCC – FK     | Tube            | SNJ54AHC32FK             | SNJ54AHC32FK        |

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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#### SN54AHC32, SN74AHC32 QUADRUPLE 2-INPUT POSITIVE-OR GATES

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## FUNCTION TABLE (each gate)

| INP | UTS | OUTPUT |
|-----|-----|--------|
| Α   | В   | Υ      |
| Н   | Х   | Н      |
| Х   | Н   | Н      |
| L   | L   | L      |

#### logic diagram (positive logic)



#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage range, V <sub>CC</sub>                            |   |
|--|---|
| Input voltage range, V <sub>I</sub> (see Note 1)                 | –0.5 V to 7 V                             |
| Output voltage range, VO (see Note 1)                            | $0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$ |
| Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0)        |   |
| Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CC}$ )   |   |
| Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ )       | ±25 mA                                    |
| Continuous current through V <sub>CC</sub> or GND                |   |
| Package thermal impedance, $\theta_{JA}$ (see Note 2): D package | 86°C/W                                    |
| (see Note 2): DB package   |   |
| (see Note 2): DGV package  | 127°C/W                                   |
| (see Note 2): N package  | 80°C/W                                    |
| (see Note 2): NS package   | 76°C/W                                    |
| (see Note 2): PW package   | 113°C/W                                   |
| (see Note 3): RGY package  | 47°C/W                                    |
| Storage temperature range, T <sub>stq</sub>                      | –65°C to 150°C                            |

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
  - 2. The package thermal impedance is calculated in accordance with JESD 51-7.
  - 3. The package thermal impedance is calculated in accordance with JESD 51-5.



### SN54AHC32, SN74AHC32 QUADRUPLE 2-INPUT POSITIVE-OR GATES

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#### recommended operating conditions (see Note 4)

|                |                                    |  | SN54A | HC32 | SN74A | HC32 | UNIT  |  |
|----------------|------------------------------------|--|-------|------|-------|------|-------|--|
|                |                                    |  | MIN   | MAX  | MIN   | MAX  | UNII  |  |
| Vcc            | Supply voltage                     |  | 2     | 5.5  | 2     | 5.5  | V     |  |
|                |                                    | V <sub>CC</sub> = 2 V                      | 1.5   |      | 1.5   |      |       |  |
| VIН            | High-level input voltage           | V <sub>CC</sub> = 3 V                      | 2.1   |      | 2.1   |      | V     |  |
|                |                                    | V <sub>CC</sub> = 5.5 V                    | 3.85  |      | 3.85  |      |       |  |
|                |                                    | V <sub>CC</sub> = 2 V                      |       | 0.5  |       | 0.5  |       |  |
| $V_{IL}$       | Low-level input voltage            | V <sub>CC</sub> = 3 V                      |       | 0.9  |       | 0.9  | V     |  |
|                |                                    | $V_{CC} = 5.5 V$                           |       | 1.65 |       | 1.65 |       |  |
| ٧ <sub>I</sub> | Input voltage                      |  | 0     | 5.5  | 0     | 5.5  | V     |  |
| ٧o             | Output voltage                     |  | 0     | VCC  | 0     | VCC  | V     |  |
|                |                                    | V <sub>CC</sub> = 2 V                      |       | -50  |       | -50  | μΑ    |  |
| ІОН            | High-level output current          | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ |       | -4   |       | -4   | mA    |  |
|                |                                    | $V_{CC} = 5 V \pm 0.5 V$                   |       | -8   |       | -8   | IIIA  |  |
|                |                                    | V <sub>CC</sub> = 2 V                      |       | 50   |       | 50   | μΑ    |  |
| lOL            | Low-level output current           | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ |       | 4    |       | 4    | 4     |  |
|                |                                    | $V_{CC} = 5 V \pm 0.5 V$                   | 8 8   |      | mA    |      |       |  |
| Δt/Δν          | Input transition rice or fall rate | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ |       | 100  |       | 100  | nc/\/ |  |
| ΔυΔν           | Input transition rise or fall rate | $V_{CC} = 5 V \pm 0.5 V$                   |       | 20   |       | 20   | ns/V  |  |
| TA             | Operating free-air temperature     |  | -55   | 125  | -40   | 85   | °C    |  |

NOTE 4: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| DADAMETED      | TEST SOMBITIONS                  | \ \ \        | T,          | λ = 25°C | ;    | SN54A | HC32 | SN74A | HC32 |      |  |
|----------------|----------------------------------|--------------|-------------|----------|------|-------|------|-------|------|------|--|
| PARAMETER      | TEST CONDITIONS                  | vcc          | MIN TYP MAX |          |      | MIN   | MAX  | MIN   | MAX  | UNIT |  |
|                |                                  | 2 V          | 1.9         | 2        |      | 1.9   |      | 1.9   |      |      |  |
|                | I <sub>OH</sub> = -50 μA         | 3 V          | 2.9         | 3        |      | 2.9   |      | 2.9   |      |      |  |
| Voн            |                                  | 4.5 V        | 4.4         | 4.5      |      | 4.4   |      | 4.4   |      | V    |  |
|                | I <sub>OH</sub> = -4 mA          | 3 V          | 2.58        |          |      | 2.48  |      | 2.48  |      |      |  |
|                | I <sub>OH</sub> = -8 mA          | 4.5 V        | 3.94        |          |      | 3.8   |      | 3.8   |      |      |  |
|                |                                  | 2 V          |             |          | 0.1  |       | 0.1  |       | 0.1  |      |  |
|                | Ι <sub>ΟL</sub> = 50 μΑ          | 3 V          |             |          | 0.1  |       | 0.1  |       | 0.1  |      |  |
| VOL            |                                  | 4.5 V        |             |          | 0.1  |       | 0.1  |       | 0.1  | V    |  |
|                | I <sub>OL</sub> = 4 mA           | 3 V          |             |          | 0.36 |       | 0.5  |       | 0.44 |      |  |
|                | I <sub>OL</sub> = 8 mA           | 4.5 V        |             |          | 0.36 |       | 0.5  |       | 0.44 |      |  |
| lį             | V <sub>I</sub> = 5.5 V or GND    | 0 V to 5.5 V |             |          | ±0.1 |       | ±1*  |       | ±1   | μΑ   |  |
| Icc            | $V_I = V_{CC}$ or GND, $I_O = 0$ | 5.5 V        |             |          | 2    |       | 20   |       | 20   | μΑ   |  |
| C <sub>i</sub> | $V_I = V_{CC}$ or GND            | 5 V          |             | 2        | 10   |       |      |       | 10   | pF   |  |

<sup>\*</sup> On products compliant to MIL-PRF-38535, this parameter is not production tested at  $V_{CC} = 0 \text{ V}$ .



#### SN54AHC32, SN74AHC32 QUADRUPLE 2-INPUT POSITIVE-OR GATES

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# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 3.3 V $\pm$ 0.3 V (unless otherwise noted) (see Figure 1)

| PARAMETER        | FROM TO |          | LOAD                   | OAD T <sub>A</sub> = 25°C |            | SN54AHC32  |            | SN74AHC32 |     | UNIT |      |    |      |   |     |     |
|------------------|---------|----------|------------------------|---------------------------|------------|------------|------------|-----------|-----|------|------|----|------|---|-----|-----|
| PARAMETER        | (INPUT) | (OUTPUT) | CAPACITANCE            | MIN                       | TYP        | MAX        | MIN        | MAX       | MIN | MAX  | UNIT |    |      |   |     |     |
| tPLH             | A or B  | V        | C 15 pE                |                           | 5.5*       | 7.9*       | 1*         | 9.5*      | 1   | 9.5  | ns   |    |      |   |     |     |
| <sup>t</sup> PHL | AUB     | '        | C <sub>L</sub> = 15 pF | C[ = 13 pr                | OL = 13 pi | OL = 10 pi | OL = 10 pi | 1         |     | 5.5* | 7.9* | 1* | 9.5* | 1 | 9.5 | 115 |
| tPLH .           | A or B  | V        | C: - 50 pE             |                           | 8          | 11.4       | 1          | 13        | 1   | 13   | ns   |    |      |   |     |     |
| <sup>t</sup> PHL | AUB     | ī        | С <sub>L</sub> = 50 pF |                           | 8          | 11.4       | 1          | 13        | 1   | 13   | 115  |    |      |   |     |     |

<sup>\*</sup> On products compliant to MIL-PRF-38535, this parameter is not production tested.

# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

| PARAMETER        | ARAMETER FROM TO LOAD |          | LOAD                   | T <sub>A</sub> = 25°C |            | SN54AHC32  |     | SN74AHC32 |      | UNIT |      |   |     |    |
|------------------|-----------------------|----------|------------------------|-----------------------|------------|------------|-----|-----------|------|------|------|---|-----|----|
| PARAMETER        | (INPUT)               | (OUTPUT) | CAPACITANCE            | MIN                   | TYP        | MAX        | MIN | MAX       | MIN  | MAX  | UNIT |   |     |    |
| t <sub>PLH</sub> | A or B                | V        | C <sub>I</sub> = 15 pF |                       | 3.8*       | 5.5*       | 1*  | 6.5*      | 1    | 6.5  | 20   |   |     |    |
| <sup>t</sup> PHL | AUB                   | ī        | CL = 15 pr             | OL = 13 pi            | OL = 10 pi | о_ = 15 рі |     | 3.8*      | 5.5* | 1*   | 6.5* | 1 | 6.5 | ns |
| t <sub>PLH</sub> | A or B                | V        | C: - 50 pE             |                       | 5.3        | 7.5        | 1   | 8.5       | 1    | 8.5  | 20   |   |     |    |
| t <sub>PHL</sub> | AUIB                  | ſ        | C <sub>L</sub> = 50 pF |                       | 5.3        | 7.5        | 1   | 8.5       | 1    | 8.5  | ns   |   |     |    |

<sup>\*</sup> On products compliant to MIL-PRF-38535, this parameter is not production tested.

### noise characteristics, $V_{CC} = 5 \text{ V}$ , $C_L = 50 \text{ pF}$ , $T_A = 25^{\circ}\text{C}$ (see Note 5)

|                    | PARAMETER                                     | SN  | UNIT |      |      |
|--------------------|---|-----|------|------|------|
|                    | PARAMETER                                     | MIN | TYP  | MAX  | UNIT |
| VOL(P)             | Quiet output, maximum dynamic V <sub>OL</sub> |     | 0.3  | 0.8  | V    |
| V <sub>OL(V)</sub> | Quiet output, minimum dynamic V <sub>OL</sub> |     | -0.3 | -0.8 | V    |
| VOH(V)             | Quiet output, minimum dynamic VOH             |     | 4.7  |      | V    |
| V <sub>IH(D)</sub> | High-level dynamic input voltage              | 3.5 |      |      | V    |
| V <sub>IL(D)</sub> | Low-level dynamic input voltage               |     |      | 1.5  | V    |

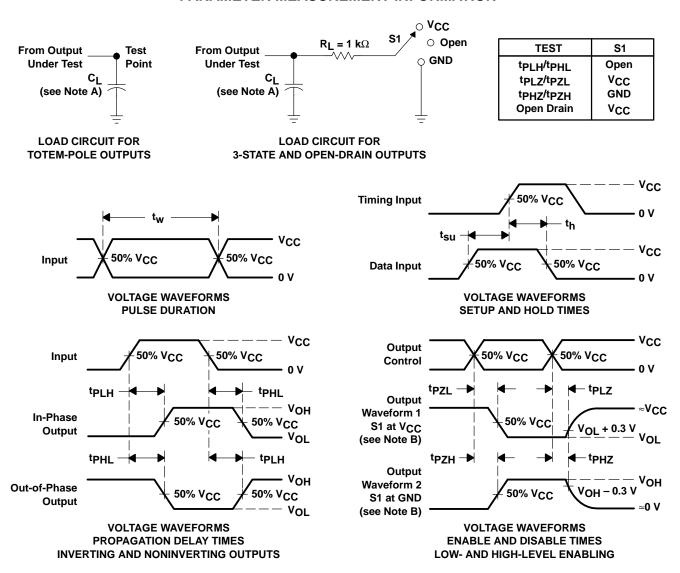
NOTE 5: Characteristics are for surface-mount packages only.

#### operating characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$

|                 | PARAMETER                     | TEST C   | ONDITIONS | TYP | UNIT |
|-----------------|-------------------------------|----------|-----------|-----|------|
| C <sub>pd</sub> | Power dissipation capacitance | No load, | f = 1 MHz | 14  | pF   |

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#### PARAMETER MEASUREMENT INFORMATION



NOTES: A.  $C_L$  includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz,  $Z_O = 50 \Omega$ ,  $t_f \leq 3$  ns.  $t_f \leq 3$  ns.
- D. The outputs are measured one at a time with one input transition per measurement.
- E. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms







26-Sep-2005

#### **PACKAGING INFORMATION**

| Orderable Device | Status <sup>(1)</sup> | Package<br>Type | Package<br>Drawing | Pins | Package<br>Qty | e Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|-----------------|--------------------|------|----------------|---------------------------|------------------|------------------------------|
| 5962-9682501Q2A  | ACTIVE                | LCCC            | FK                 | 20   | 1              | TBD                       | Call TI          | Level-NC-NC-NC               |
| 5962-9682501QCA  | ACTIVE                | CDIP            | J                  | 14   | 1              | TBD                       | Call TI          | Level-NC-NC-NC               |
| 5962-9682501QDA  | ACTIVE                | CFP             | W                  | 14   | 1              | TBD                       | Call TI          | Level-NC-NC-NC               |
| SN74AHC32D       | ACTIVE                | SOIC            | D                  | 14   | 50             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AHC32DBLE    | OBSOLETE              | SSOP            | DB                 | 14   |                | TBD                       | Call TI          | Call TI                      |
| SN74AHC32DBR     | ACTIVE                | SSOP            | DB                 | 14   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AHC32DBRE4   | ACTIVE                | SSOP            | DB                 | 14   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AHC32DE4     | ACTIVE                | SOIC            | D                  | 14   | 50             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AHC32DGVR    | ACTIVE                | TVSOP           | DGV                | 14   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AHC32DGVRE4  | ACTIVE                | TVSOP           | DGV                | 14   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AHC32DR      | ACTIVE                | SOIC            | D                  | 14   | 2500           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AHC32DRE4    | ACTIVE                | SOIC            | D                  | 14   | 2500           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AHC32N       | ACTIVE                | PDIP            | N                  | 14   | 25             | Pb-Free<br>(RoHS)         | CU NIPDAU        | Level-NC-NC-NC               |
| SN74AHC32NE4     | ACTIVE                | PDIP            | N                  | 14   | 25             | Pb-Free<br>(RoHS)         | CU NIPDAU        | Level-NC-NC-NC               |
| SN74AHC32NSR     | ACTIVE                | SO              | NS                 | 14   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AHC32NSRE4   | ACTIVE                | SO              | NS                 | 14   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AHC32PW      | ACTIVE                | TSSOP           | PW                 | 14   | 90             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AHC32PWE4    | ACTIVE                | TSSOP           | PW                 | 14   | 90             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AHC32PWG4    | ACTIVE                | TSSOP           | PW                 | 14   | 90             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AHC32PWLE    | OBSOLETE              | TSSOP           | PW                 | 14   |                | TBD                       | Call TI          | Call TI                      |
| SN74AHC32PWR     | ACTIVE                | TSSOP           | PW                 | 14   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AHC32PWRE4   | ACTIVE                | TSSOP           | PW                 | 14   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AHC32PWRG4   | ACTIVE                | TSSOP           | PW                 | 14   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AHC32RGYR    | ACTIVE                | QFN             | RGY                | 14   | 1000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-2-260C-1YEAR           |
| SNJ54AHC32FK     | ACTIVE                | LCCC            | FK                 | 20   | 1              | TBD                       | Call TI          | Level-NC-NC-NC               |
| SNJ54AHC32J      | ACTIVE                | CDIP            | J                  | 14   | 1              | TBD                       | Call TI          | Level-NC-NC-NC               |
| SNJ54AHC32W      | ACTIVE                | CFP             | W                  | 14   | 1              | TBD                       | Call TI          | Level-NC-NC-NC               |

 $<sup>^{(1)}</sup>$  The marketing status values are defined as follows:



#### PACKAGE OPTION ADDENDUM

26-Sep-2005

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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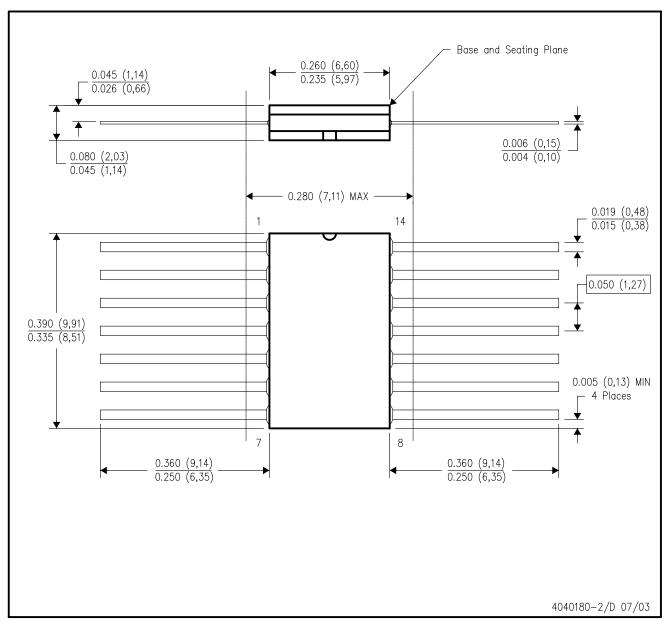
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- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

## W (R-GDFP-F14)

### CERAMIC DUAL FLATPACK



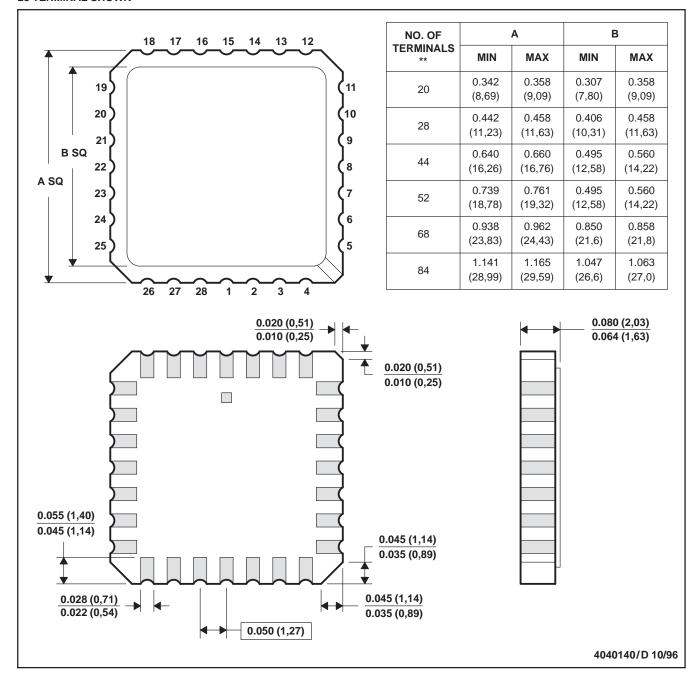
- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F14 and JEDEC MO-092AB



#### FK (S-CQCC-N\*\*)

#### **28 TERMINAL SHOWN**

#### LEADLESS CERAMIC CHIP CARRIER



- NOTES: A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package can be hermetically sealed with a metal lid.
  - D. The terminals are gold plated.
  - E. Falls within JEDEC MS-004



### N (R-PDIP-T\*\*)

#### PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.

#### DGV (R-PDSO-G\*\*)

#### **24 PINS SHOWN**

#### **PLASTIC SMALL-OUTLINE**



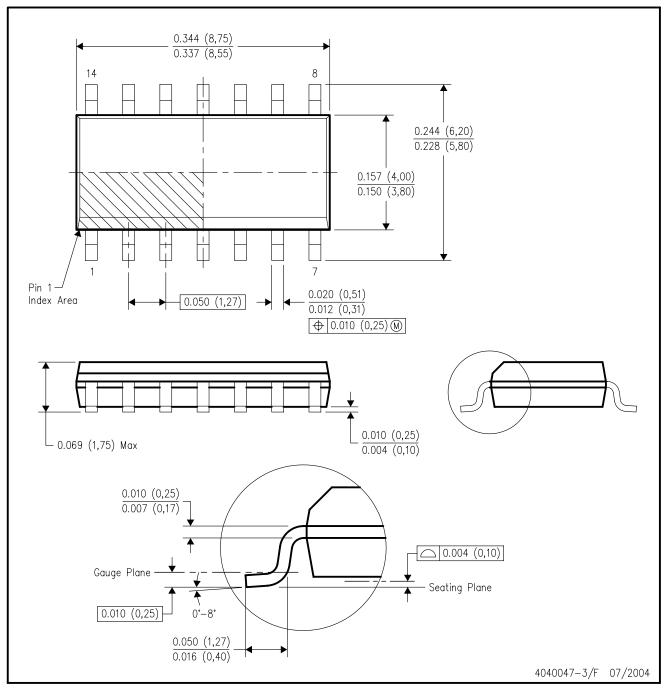
NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
- D. Falls within JEDEC: 24/48 Pins MO-153 14/16/20/56 Pins – MO-194



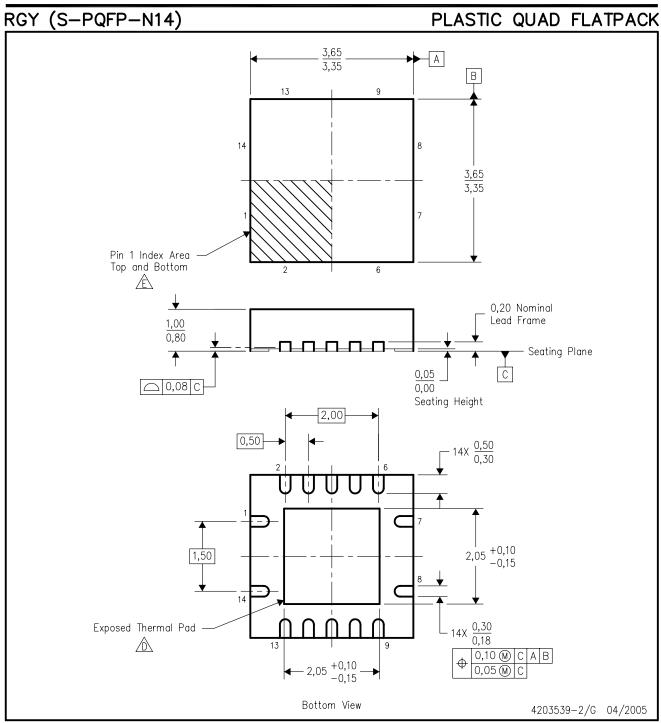
## D (R-PDSO-G14)

### PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AB.





NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.

- B. This drawing is subject to change without notice.
- C. QFN (Quad Flatpack No-Lead) package configuration.
- $ilde{\mathbb{D}}$  The package thermal pad must be soldered to the board for thermal and mechanical performance.
- Pin 1 identifiers are located on both top and bottom of the package and within the zone indicated. The Pin 1 identifiers are either a molded, marked, or metal feature.
- F. Package complies to JEDEC MO-241 variation BA.



#### **MECHANICAL DATA**

#### NS (R-PDSO-G\*\*)

#### 14-PINS SHOWN

#### PLASTIC SMALL-OUTLINE PACKAGE



- . All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



#### DB (R-PDSO-G\*\*)

#### **PLASTIC SMALL-OUTLINE**

#### **28 PINS SHOWN**



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-150



#### PW (R-PDSO-G\*\*)

#### 14 PINS SHOWN

#### PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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